

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC7MBL6353SFT, TC7MBL6353SFK, TC7MBL6353SFTG

Low Voltage/Low Capacitance Dual 1-of-2 Multiplexer/Demultiplexer

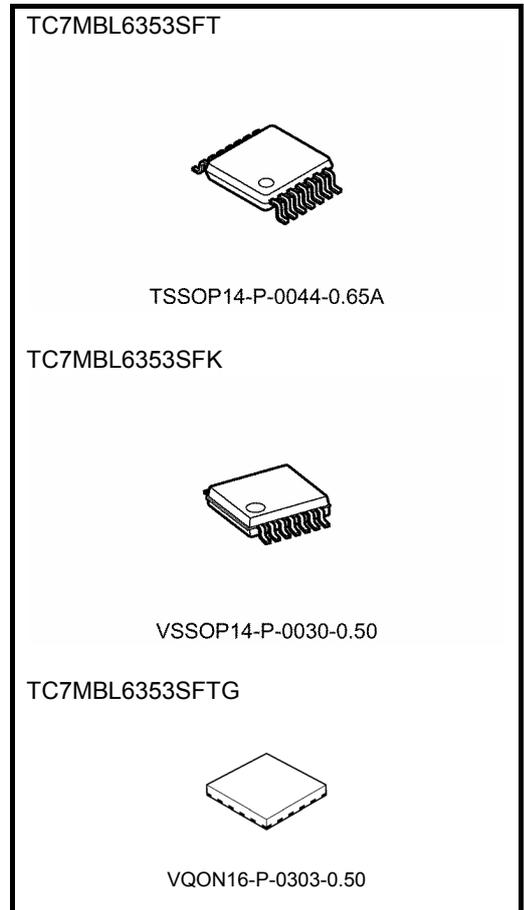
The TC7MBL6353S is a Low Voltage/Low Capacitance CMOS Dual 1-of-2 Multiplexer/Demultiplexer. The low on-resistance of the switch allows connections to be made with minimal propagation delay time.

This device consists of two individual two-inputs multiplexer/demultiplexer with common select input (S) and output enable ( $\overline{OE}$ ). The A input is connected to the B1 or B2 outputs as determined by the combination of both the select input (S) and output enable ( $\overline{OE}$ ). When the output enable ( $\overline{OE}$ ) input is held at "H" level, the switches are open regardless of the state of the select inputs, and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

### Features

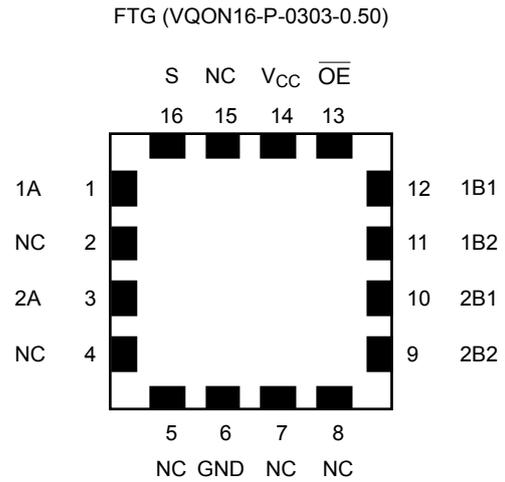
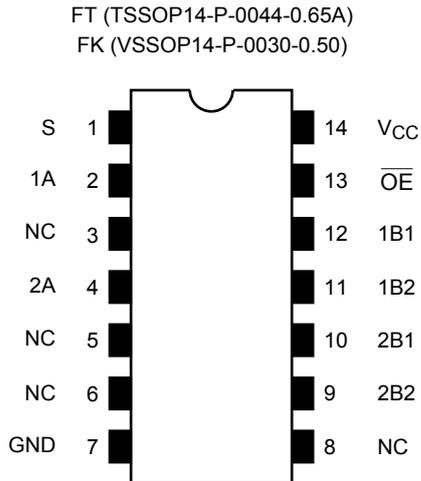
- Operating voltage:  $V_{CC} = 1.65 \sim 3.6 \text{ V}$
- Low capacitance:  $C_{I/O} = 15 \text{ pF}$  Switch On (typ.) @3 V
- Low on-resistance:  $R_{ON} = 9 \Omega$  (typ.) @3 V
- ESD performance: Machine model  $\geq \pm 200 \text{ V}$   
Human body model  $\geq \pm 2000 \text{ V}$
- Power-down protection for inputs ( $\overline{OE}$  input only)
- Package: TSSOP14, VSSOP (US14), VQON16



Weight		
TSSOP14-P-0044-0.65A	:	0.06 g (typ.)
VSSOP14-P-0030-0.50	:	0.02 g (typ.)
VQON16-P-0303-0.50	:	0.013 g (typ.)

Note: When mounting VQON package, the type of recommended flux is RA or RMA.

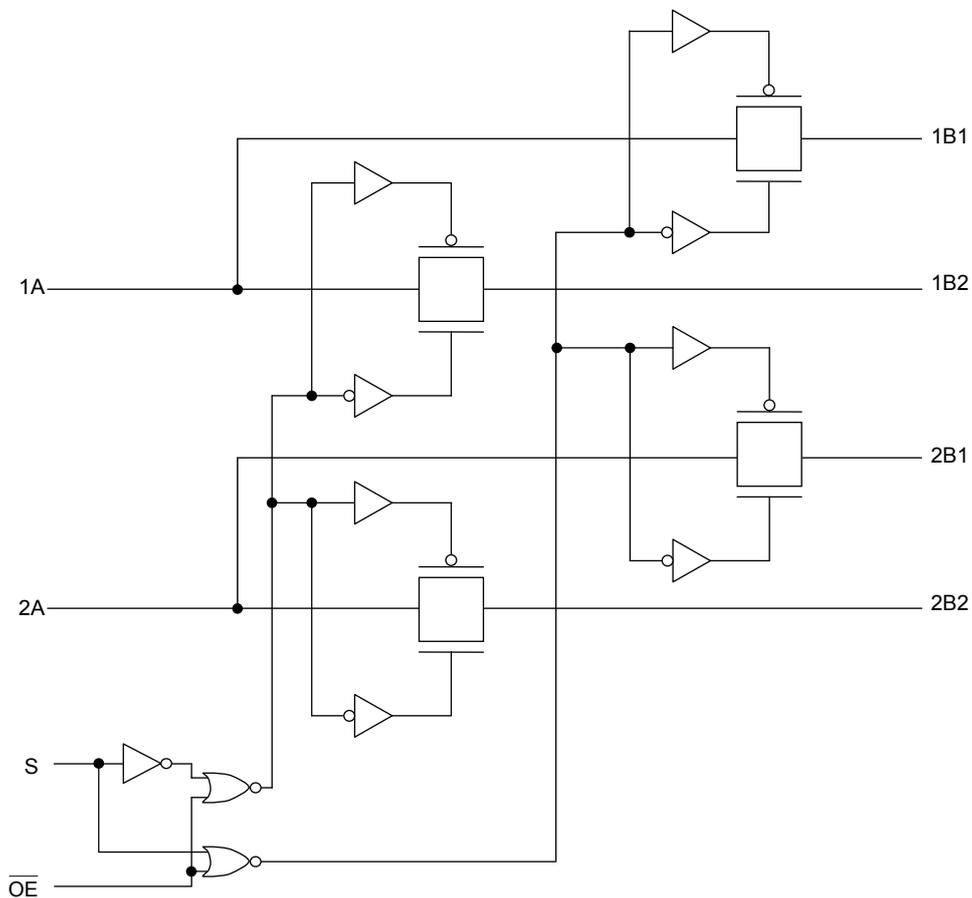
## Pin Assignment (top view)



## Truth Table

Inputs		Function
S	$\overline{OE}$	
X	H	Disconnect
L	L	nA port = nB1 port
H	L	nA port = nB2 port

## System Diagram



## Absolute Maximum Ratings (Note)

Characteristic		Symbol	Rating	Unit
Power supply range		$V_{CC}$	-0.5~4.6	V
Control pin input voltage		$V_{IN}$	-0.5~4.6	V
Switch terminal I/O voltage		$V_S$	-0.5~ $V_{CC} + 0.5$	V
Clump diode current	Control input pin	$I_{IK}$	-50	mA
	Switch terminal		±50	mA
Switch I/O current		$I_S$	50	mA
Power dissipation		$P_D$	180	mW
DC $V_{CC}$ /GND current		$I_{CC}/I_{GND}$	±100	mA
Storage temperature		$T_{stg}$	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Operating Ranges (Note)

Characteristic		Symbol	Rating	Unit
Power supply voltage		$V_{CC}$	1.65~3.6	V
Control pin input voltage		$V_{IN}$	0~3.6	V
Switch I/O voltage		$V_S$	0~ $V_{CC}$	V
Operating temperature		$T_{opr}$	-40~85	°C
Input rise and fall time		dt/dv	0~10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

## Electrical Characteristics

### DC Characteristics (Ta = -40~85°C)

Parameter		Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Typ.	Max	Unit
Input voltage	"H" level	V <sub>IH</sub>	—	1.65~3.6	0.7 × V <sub>CC</sub>	—	—	V
	"L" level	V <sub>IL</sub>	—	1.65~3.6	—	—	0.3 × V <sub>CC</sub>	
Input leakage current ( $\overline{OE}$ , S)		I <sub>IN</sub>	V <sub>IN</sub> = 0~3.6V	1.65~3.6	—	—	±1.0	μA
Power-off leakage current		I <sub>OFF</sub>	$\overline{OE}$ = 0~3.6 V	0	—	—	1.0	μA
Off-state leakage current (switch off)		I <sub>SZ</sub>	A, B = 0~V <sub>CC</sub> , $\overline{OE}$ = V <sub>CC</sub>	1.65~3.6	—	—	±1.0	μA
On resistance (Note2)	R <sub>ON</sub>	V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 30 mA (Note1)	3.0	—	9	13	Ω	
		V <sub>IS</sub> = 3.0 V, I <sub>IS</sub> = 30 mA (Note1)	3.0	—	15	20		
		V <sub>IS</sub> = 2.4 V, I <sub>IS</sub> = 15 mA (Note1)	3.0	—	19	27		
		V <sub>IS</sub> = 0 V, I <sub>IS</sub> = 24 mA (Note1)	2.3	—	10	16		
		V <sub>IS</sub> = 2.3 V, I <sub>IS</sub> = 24 mA (Note1)	2.3	—	17	24		
		V <sub>IS</sub> = 2.0 V, I <sub>IS</sub> = 15 mA (Note1)	2.3	—	21	30		
Increase in I <sub>CC</sub> per input		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND, I <sub>OUT</sub> = 0	3.6	—	—	10	μA

Note1: All typical values are at Ta=25°C.

Note2: Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

### AC Characteristics (Ta = -40~85°C)

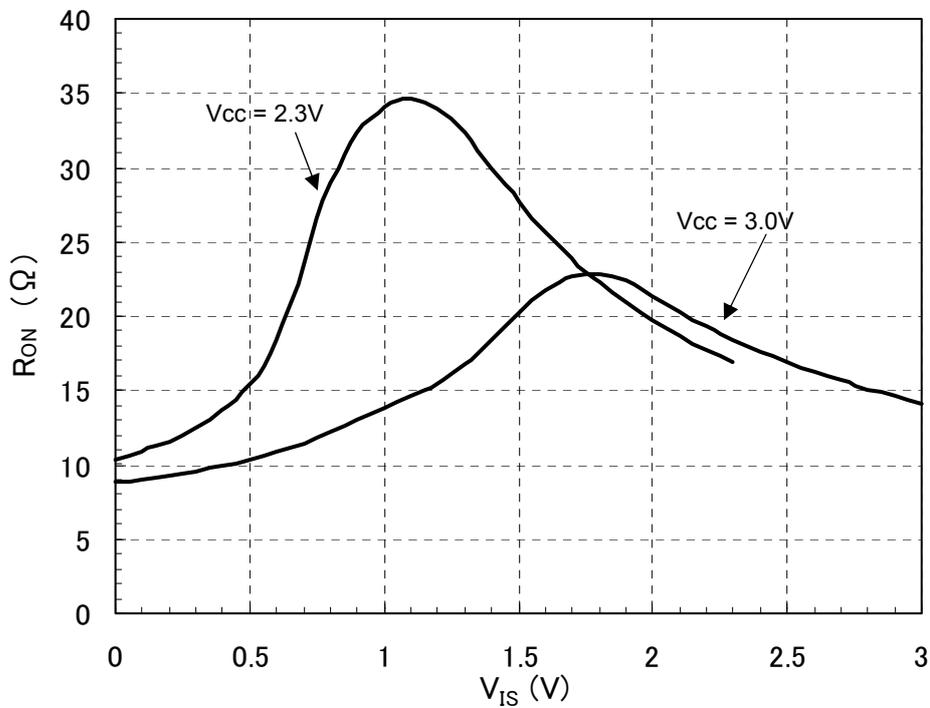
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time (S to bus)	t <sub>pLH</sub> t <sub>pHL</sub>	Figure 1, Figure 2	3.3 ± 0.3	—	6	ns
			2.5 ± 0.2	—	7	
			1.8 ± 0.15	—	11	
Output enable time ( $\overline{OE}$ to bus)	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	3.3 ± 0.3	—	6	ns
			2.5 ± 0.2	—	7	
			1.8 ± 0.15	—	11	
Output enable time (S to bus)	t <sub>pZL</sub> t <sub>pZH</sub>	Figure 1, Figure 3	3.3 ± 0.3	—	6	ns
			2.5 ± 0.2	—	7	
			1.8 ± 0.15	—	11	
Output disable time ( $\overline{OE}$ to bus)	t <sub>pLZ</sub> t <sub>pHZ</sub>	Figure 1, Figure 3	3.3 ± 0.3	—	6	ns
			2.5 ± 0.2	—	7	
			1.8 ± 0.15	—	11	
Output disable time (S to bus)	t <sub>pLZ</sub> t <sub>pHZ</sub>	Figure 1, Figure 3	3.3 ± 0.3	—	6	ns
			2.5 ± 0.2	—	7	
			1.8 ± 0.15	—	11	

**Capacitive Characteristics (Ta = 25°C)**

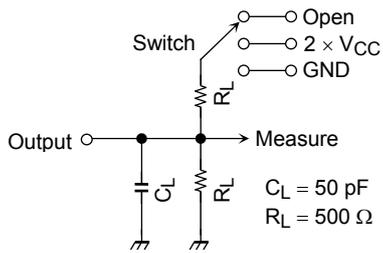
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Typ.	Unit
Control pin input capacitance ( $\overline{OE}$ , S)	C <sub>IN</sub>		3.0	3	pF
Switch terminal capacitance (B1~2)	C <sub>I/O</sub>	$\overline{OE} = V_{CC}$ (switch off)	3.0	6	pF
Switch terminal capacitance (A)	C <sub>I/O</sub>	$\overline{OE} = V_{CC}$ (switch off)	3.0	9	pF
Switch terminal capacitance	C <sub>I/O</sub>	$\overline{OE} = GND$ (switch on)	3.0	15	pF

Note: This parameter is guaranteed by design

▪ **R<sub>ON</sub> Characteristic (typ.) Ta=25°C**



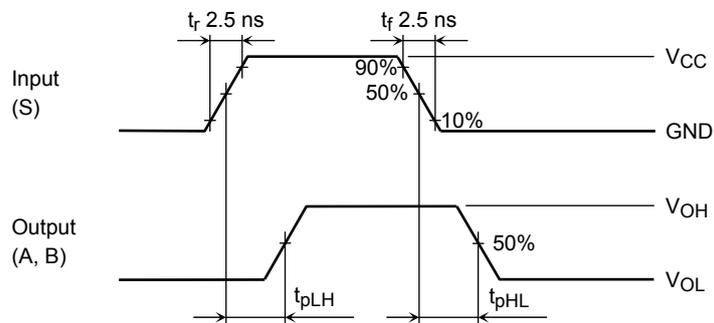
**AC Test Circuit**



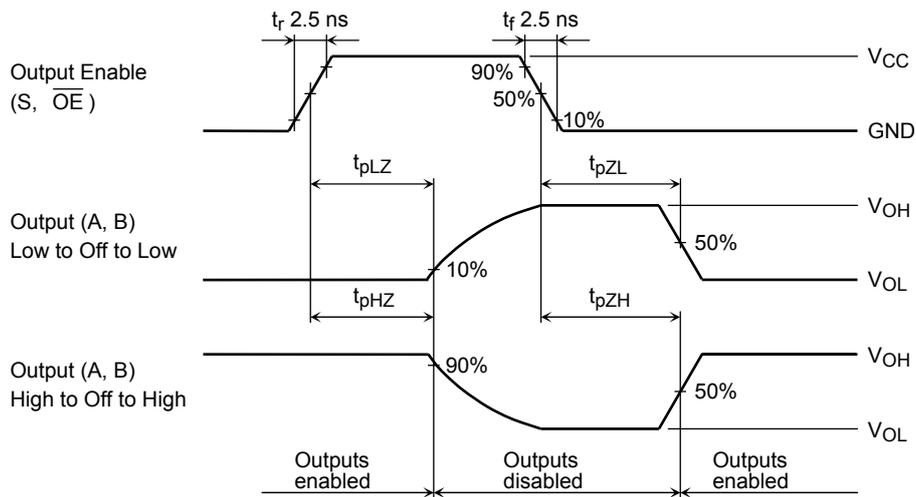
Parameter	Switch
$t_{pLH}$ , $t_{pHL}$	Open
$t_{pLZ}$ , $t_{pZL}$	$2 \times V_{CC}$
$t_{pHZ}$ , $t_{pZH}$	GND

**Figure 1**

**AC Waveform**



**Figure 2  $t_{pLH}$ ,  $t_{pHL}$**



**Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$**

**Rise and Fall Times (tr / tf) of the TC7MBL6353S I/O Signals**

The tr(out) and tf(out) values of the output signals are affected by the CR time constant of the input, which consists of the switch terminal capacitance (C<sub>I/O</sub>) and the on-resistance (R<sub>ON</sub>) of the input.

In practice, the tr(out) and tf(out) values are also affected by the circuit's capacitance and resistance components other than those of the TC7MBL6353S.

The tr / tf (out) values can be approximated as follows. (Figure 4 shows the test circuit.)

$$tr / tf \text{ out (approx)} = - ( C_{I/O} + C_L ) \cdot ( R_{DRIVE} + R_{ON} ) \cdot \ln ( ( ( V_{OH} - V_{OL} ) - V_M ) / ( V_{OH} - V_{OL} ) )$$

where, R<sub>DRIVE</sub> is the output impedance of the previous-stage circuit.

Calculation example:

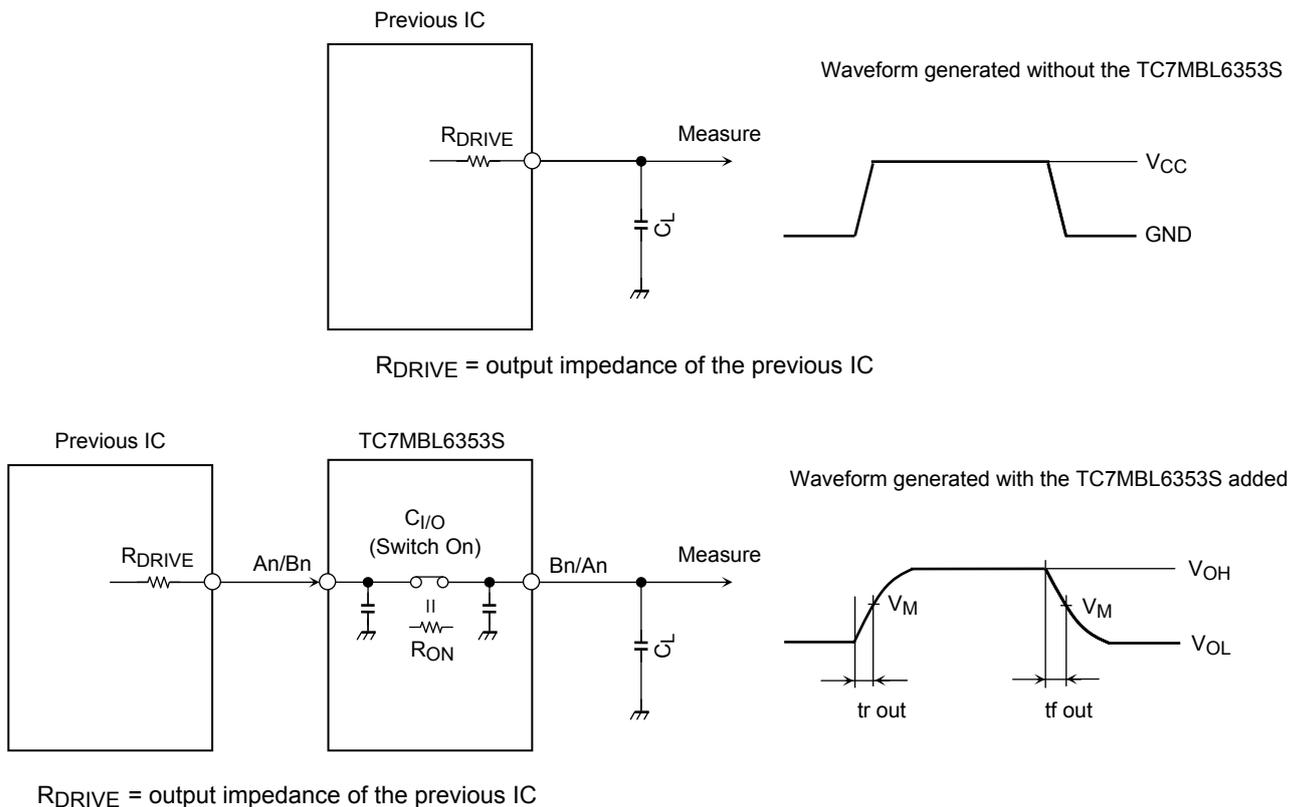
$$tr \text{ out (approx)} = - ( 15 + 15 ) E-12 \cdot ( 120 + 9 ) \cdot \ln ( ( ( 3.0 - 0 ) - 1.5 ) / ( 3.0 - 0 ) )$$

$$\approx 2.7 \text{ ns}$$

Calculation conditions:

V<sub>CC</sub> = 3.0V , C<sub>L</sub> = 15pF , R<sub>DRIVE</sub> = 120Ω (output impedance of the previous IC), V<sub>M</sub> = 1.5V (V<sub>CC</sub> / 2)

Output of the previous IC = digital (i.e., high-level voltage = V<sub>CC</sub>; low-level voltage = GND)



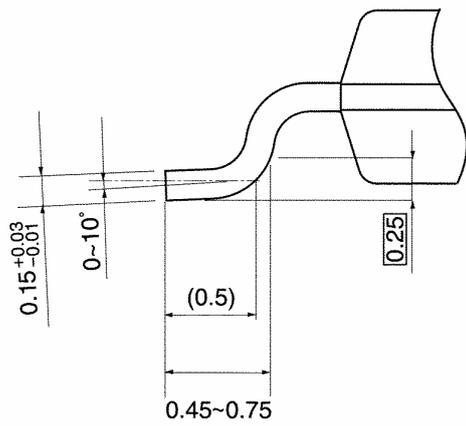
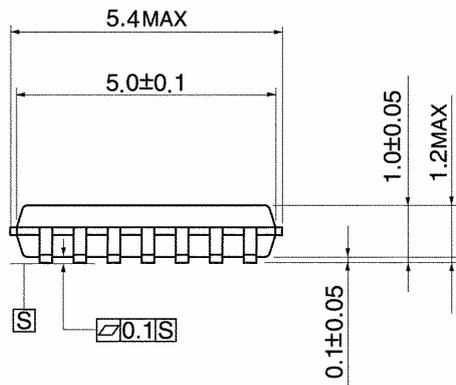
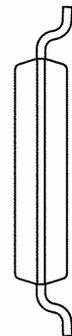
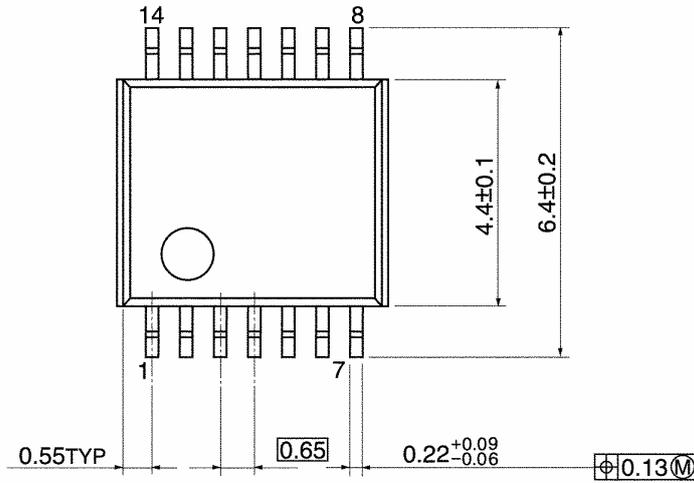
Parameter	V <sub>CC</sub>		
		3.3 ± 0.3 V	2.5 ± 0.2 V
V <sub>M</sub>	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2

**Figure 4 Test Circuit**

**Package Dimensions**

TSSOP14-P-0044-0.65A

Unit: mm

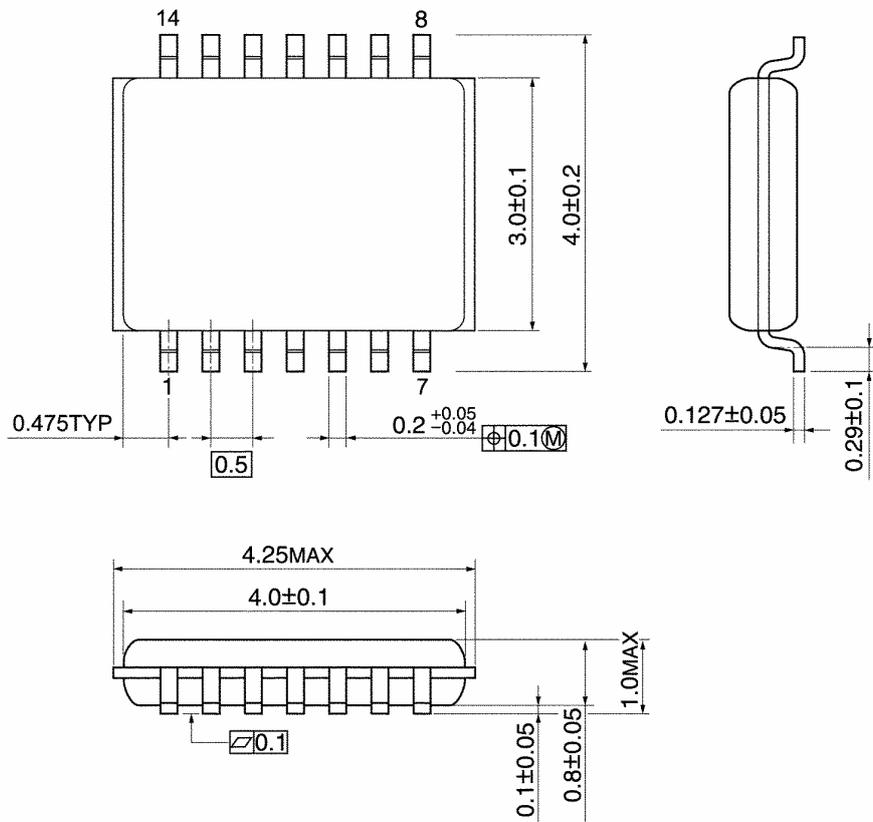


Weight: 0.06 g (typ.)

**Package Dimensions**

VSSOP14-P-0030-0.50

Unit: mm

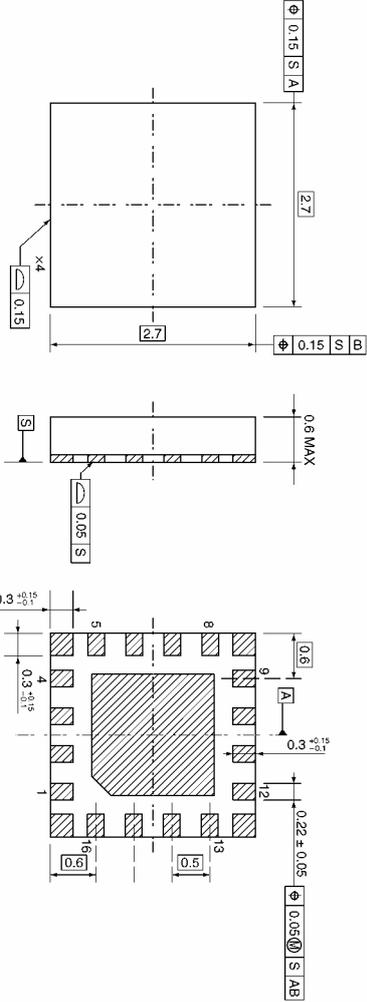


Weight: 0.02 g (typ.)

Package Dimensions

VQON16-P-0303-0.50

Unit: mm



Weight: 0.013 g (typ.)

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20070701-EN GENERAL

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